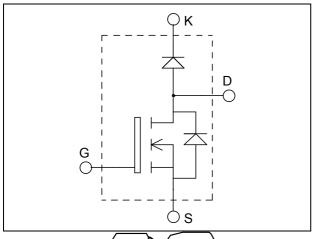


ISOTOP[®] Boost chopper Super Junction MOSFET Power Module





APT33N90JCU2

 $V_{DSS} = 900V$ $R_{DSon} = 120m\Omega \text{ max} @ \text{Tj} = 25^{\circ}\text{C}$ $I_D = 33\text{A} @ \text{Tc} = 25^{\circ}\text{C}$

Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction
- Brake switch

Features

- COOLMOS
 - Power Semiconductors
 - Ultra low R_{DSon}
 - Low Miller capacitance
 - Ultra low gate chargeAvalanche energy rated
- ISOTOP[®] Package (SOT-227)
- Isoffor Fackage (SOT-227)
 Very low stray inductance
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive T_C of V_{CEsat}
- RoHS Compliant

Absolute maximum ratings

| Symbol | Parameter | | Max ratings | Unit |
|-------------------|---|---------------------|-------------|------|
| V _{DSS} | Drain - Source Breakdown Voltage | | 900 | V |
| т | Continuous Drain Current | $T_c = 25^{\circ}C$ | 33 | |
| I _D | Continuous Drain Current | $T_c = 80^{\circ}C$ | 25 | Α |
| I _{DM} | Pulsed Drain current | | 75 | |
| V _{GS} | Gate - Source Voltage | | ± 20 | V |
| R _{DSon} | Drain - Source ON Resistance | | 120 | mΩ |
| PD | Maximum Power Dissipation | $T_c = 25^{\circ}C$ | 290 | W |
| I _{AR} | Avalanche current (repetitive and non repetitive) | | 8.8 | Α |
| EAR | Repetitive Avalanche Energy | | 2.9 | mJ |
| E _{AS} | Single Pulse Avalanche Energy | | 1940 | 1115 |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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All ratings (a) $T_i = 25^{\circ}C$ unless otherwise specified

Electrical Characteristics Symbol **Characteristic Test Conditions** Min Тур Max Unit $V_{GS} = 0V, V_{DS} = 900V$ $T_i = 25^{\circ}C$ 100 Zero Gate Voltage Drain Current IDSS μA $V_{GS} = 0V, V_{DS} = 900V$ 500 $T_i = 125^{\circ}C$ $R_{D\underline{S}(on)}$ Drain – Source on Resistance 100 120 mΩ Gate Threshold Voltage 2.5 3 3.5 V V_{GS(th)} Gate - Source Leakage Current 100 IGSS nA

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------|--|-----|------|-----|------|
| C _{iss} | Input Capacitance | $V_{GS} = 0V$; $V_{DS} = 100V$ | | 6.8 | | nF |
| C _{oss} | Output Capacitance | f = 1MHz | | 0.33 | | m |
| Qg | Total gate Charge | $V_{GS} = 10V$ | | 270 | | |
| Q_{gs} | Gate – Source Charge | $V_{Bus} = 400 V$ | | 32 | | nC |
| Q_{gd} | Gate – Drain Charge | $I_D = 26A$ | 115 | | | |
| T _{d(on)} | Turn-on Delay Time | Inductive Switching (125°C) | | 70 | | |
| T _r | Rise Time | $V_{GS} = 10V$ $V_{Bus} = 600V$ $I_D = 26A$ | | 20 | | |
| T _{d(off)} | Turn-off Delay Time | | | 400 | | ns |
| $T_{\rm f}$ | Fall Time | $R_G = 7.5\Omega$ | | 25 | | |
| Eon | Turn-on Switching Energy | Inductive switching @ 25°C | | 1.5 | | in I |
| E _{off} | Turn-off Switching Energy | $V_{GS} = 10V; V_{Bus} = 600V$ $I_D = 26A; R_G = 7.5\Omega$ | | 0.75 | | mJ |
| Eon | Turn-on Switching Energy | Inductive switching @ 125°C | | 2.1 | | |
| E_{off} | Turn-off Switching Energy | $V_{GS} = 10V; V_{Bus} = 600V$ $I_D = 26A; R_G = 7.5\Omega$ | | 0.85 | | mJ |

Chopper diode ratings and characteristics

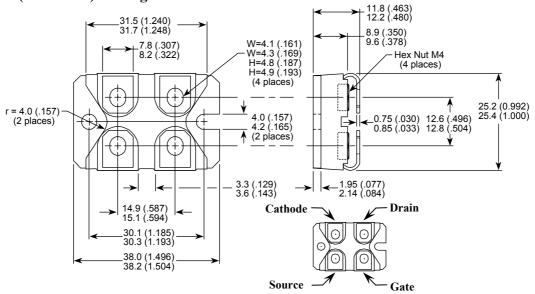
| Symbol | Characteristic | Test Conditions | | Min | Тур | Max | Unit | |
|------------------|---|--|------------------------|------|------|-----|------|--|
| V _{RRM} | Maximum Peak Repetitive Reverse Voltage | | | 1200 | | | V | |
| I _{RM} | Maximum Reverse Leakage Current | $V_{R} = 1200V$ | $T_j = 25^{\circ}C$ | | | 100 | μA | |
| *KM | Wuxiniani Keveise Deakage Cartein | V R 1200V | $T_{j} = 125^{\circ}C$ | | | 500 | μη | |
| I _F | DC Forward Current | | $T_c = 80^{\circ}C$ | | 30 | | Α | |
| | | $I_F = 30A$ | | | 2.6 | 3.1 | | |
| V _F | Diode Forward Voltage | $I_F = 60A$ | | | 3.2 | | V | |
| | | $I_F = 30A$ | $T_{j} = 125^{\circ}C$ | | 1.8 | | | |
| t | Reverse Recovery Time | | $T_j = 25^{\circ}C$ | | 300 | | ns | |
| t _{rr} | Reverse Recovery Time | $I_{\rm F} = 30 \text{A}$ $V_{\rm R} = 800 \text{V}$ | $T_{j} = 125^{\circ}C$ | | 380 | | | |
| Q _{rr} | Reverse Recovery Charge | di/dt=200A/µs | | | 360 | | nC | |
| Vrr | Reverse Receivery charge | | $T_{j} = 125^{\circ}C$ | | 1700 | | пс | |



Thermal and package characteristics

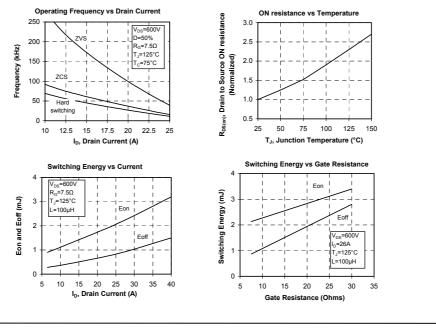
| Symbol | Characteristic | | Min | Тур | Max | Unit |
|-------------------|--|---------|------|------|------|------|
| R _{thJC} | Junction to Case Thermal Resistance | CoolMOS | | | 0.43 | |
| | sunction to case Therman Resistance | Diode | | | 1.05 | °C/W |
| R _{thJA} | Junction to Ambient (IGBT & Diode) | | | | 20 | |
| V _{ISOL} | RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz | | 2500 | | | V |
| T_J, T_{STG} | Storage Temperature Range | | -40 | | 150 | °C |
| T _L | Max Lead Temp for Soldering:0.063" from case for 10 sec | | | | 300 | C |
| Torque | Mounting torque (Mounting = 8-32 or 4mm Machine and terminals = 4mm Machine) | | | | 1.5 | N.m |
| Wt | Package Weight | | | 29.2 | | g |

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

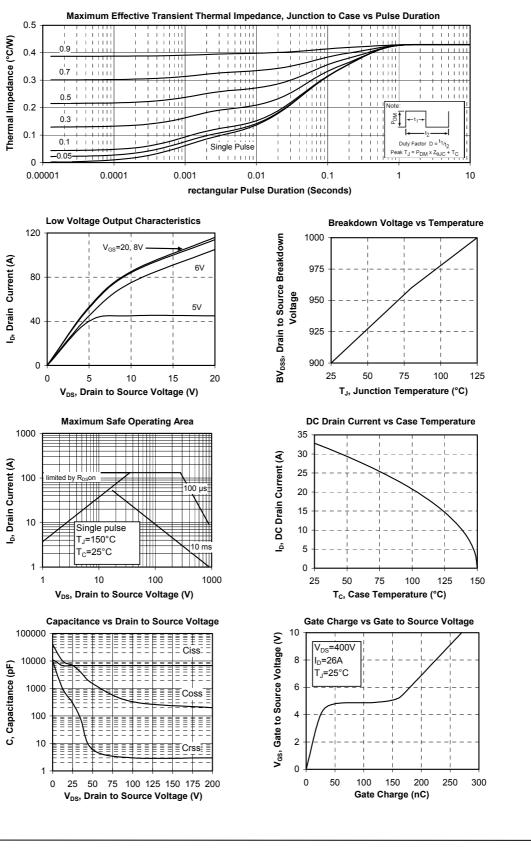
Typical CoolMOS performance Curve



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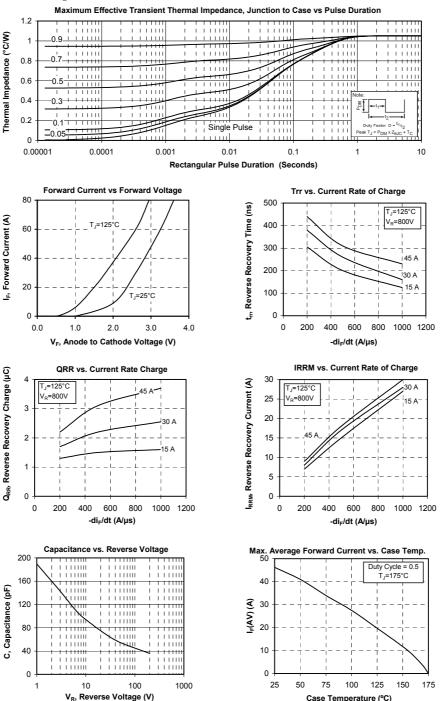
3 - 6







Typical Chopper diode performance Curve



"COOLMOS™ comprise a new family of transistors developed by Infineon Technologies AG. "COOLMOS" is a trademark of Infineon Technologies AG".



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| <u>25.163.2453.0</u> <u>25.163.4253.0</u> <u>25.190.2053.0</u> <u>25.194.3453.0</u> <u>25.320.4853.1</u> <u>25.320.5253.1</u> <u>25.326.3253.1</u> <u>25.326.3553.1</u> <u>25.330.1653.1</u> |
| <u>25.330.4753.1</u> <u>25.330.5253.1</u> <u>25.334.3253.1</u> <u>25.334.3353.1</u> <u>25.350.2053.0</u> <u>25.352.4753.1</u> <u>25.522.3253.0</u> <u>T483C</u> <u>T484C</u> <u>T485F</u> |
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| 25.640.5053.0 |